COMBINED DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled UNDERFILL SYSTEM FOR SEMICONDUCTOR PACKAGE, the specification of which:

\boxtimes	is attached hereto.			
	was filed on as Application No			
	and was amended on	(if applicable)		
	with amendments through _	(if applicable) (if applicable).		
specification, including	ng the claims, as amended by	erstand the contents of the abo any amendment referred to ab	ove.	
	•	tion which is material to the parties of Federal Regulations, Sec.		lity
(a)-(d) or §365(b) of a of any PCT internation United States of Ame for patent or inventor	any foreign application(s) for onal application which designa- crica, listed below and have al	er Title 35, United States Code patent or inventor's certificate ated at least one country other so identified below any foreign ternational application having y is claimed:	e, or §36 than the n applic	55(a) e ation
Prior Foreign Application(s)			Claim Priorit	
2001-1306	Republic of Korea	10 January 2001		
(Number)	(Country)	(Day/Month/Year Filed)		No
	the benefit under Title 35, Upnal application listed below:	nited States Code, Sec. 119(e)	of any	
Provisional Application No.		Filing Date		
I hereby claim	 the benefit under Title 35_U	nited States Code, Sec. 120 or	- · 8365(c) of

prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Sec. 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, Sec. 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application No.) (Filing Date) (Status) (patented, pending, abandoned)

I hereby appoint the following attorneys to prosecute the application, to file a corresponding international application, to prosecute and transact all business in the Patent and Trademark Office connected therewith:

20575

PATENT TRADEMARK OFFICE

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that

these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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